BMS MASTER BOARD

MAJOR REVISION HISTORY:

PCB REV.	SCH. REV.	DESCRIPTION	DATE
1.0	1.0	Schematic Baselined.	18-NOV-2021

PAGE DESCRIPTION

PAGE01: COVER PAGE

PAGE02: BLOCK DIAGRAM

PAGE03: MCU

PAGE04: ISOSPI INTERFACE

PAGE05: CAN INTERFACE

PAGE06: USB & CONTACTOR INTERFACE

PAGE07: ARDUINO CONNECTOR

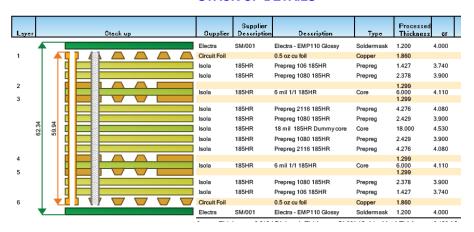
PAGE08: FRC CONNECTOR

PAGE09: POWER SUPPLY

PAGE10: REVISION HISTORY

Device Interface Address 1 DEBUG --- NA 2 150SF1 SF10 NA 3 FRC Connector SF10 NA 4 CAN Controller SF11 NA 5 Ardmino SF12 NA 6 Ardmino UARTO NA 7 Ardmino 12CO NA 8 EERSOM 12CO R/W- OMA1/OMAO

STACK UP DETAILS



PCB MECHANICAL DETAILS:

1. PCB SIZE: 100mm X 90mm

2. PCB MATERIAL: FR4

3. NUMBER OF LAYERS: 6

4. PCB THICKNESS: 1.6mm

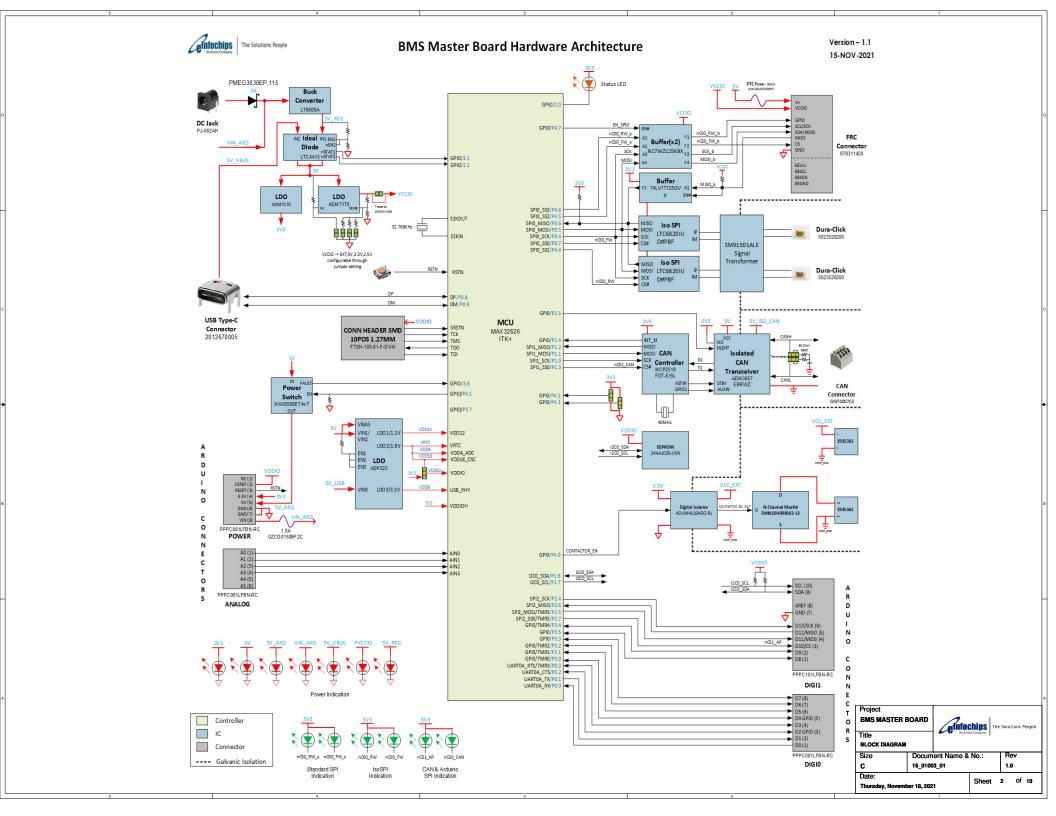
5. IMPEDANCE CONTROL: YES

NOTES, UNLESS OTHERWISE SPECIFIED:

1. RESISTANCE VALUES ARE IN OHM.

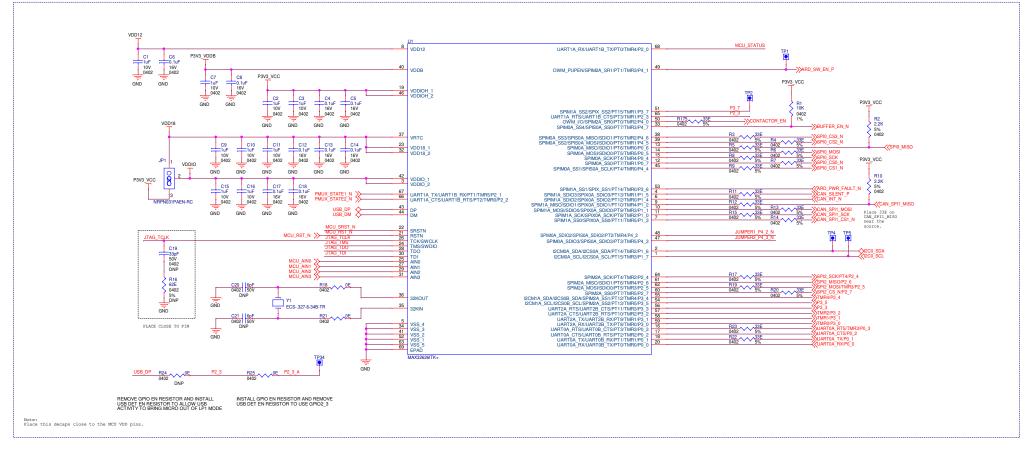
2. PARTS NOT INSTALLED ARE INDICATED WITH 'DNP'.



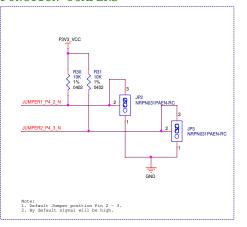


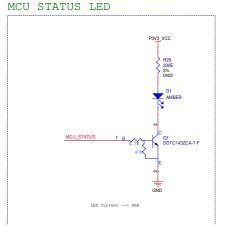
MCU SUBSYSTEM

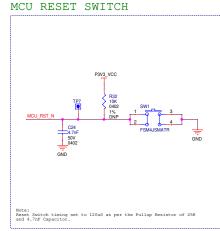


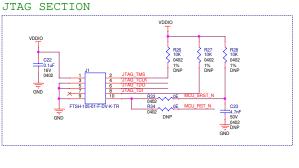


FUNCTION JUMPERS





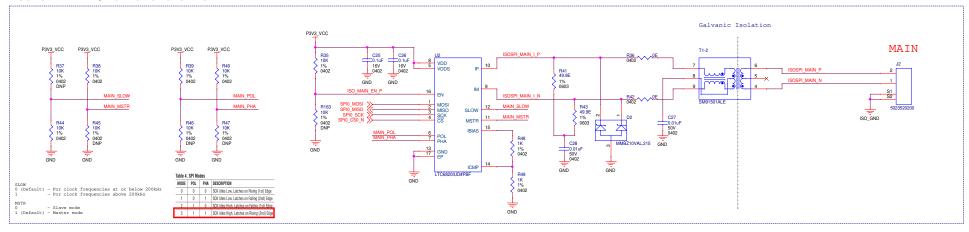




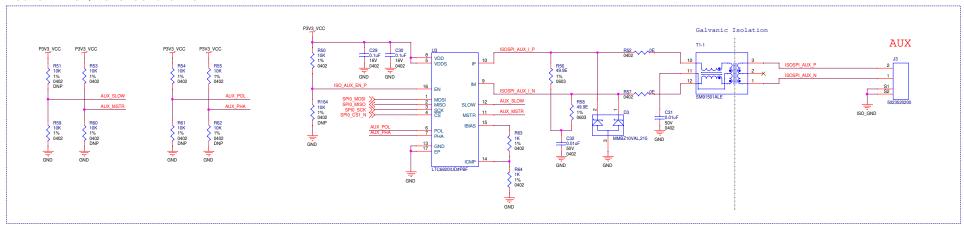
Project BMS MASTER BO	DARD	einfo	chins The	· Solutions Per	ople
Title MCU		An Arrow Company			
Size	Docum	ent Name &	No.:	Rev	
SIZE					
C	16_0100			1.0	

ISO SPI INTERFACE

ISO SPI MAIN/Forward Channel



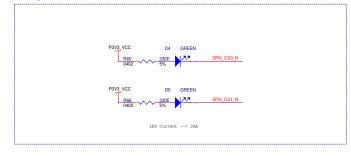
ISO SPI AUX/Reverse Channel



Layout Note:

- 1. The transformer should be placed as close to the iso-SPI cable connector as possible. The distance should be kept less than 2cm. The LTC6820 should be placed at least lcm to 2cm away from the transformer to help isolate the IC from the magnetic coupling fields.
- 2. On the top layer, no ground plane should be placed under the magnetic, the isoSPI connector, or in between the transformer and the connector.
- 3. The IP and IM traces should be isolated from surrounding circuits. No traces should cross the IP and IM lines, unless separated by a ground plane within the printed circuit board.

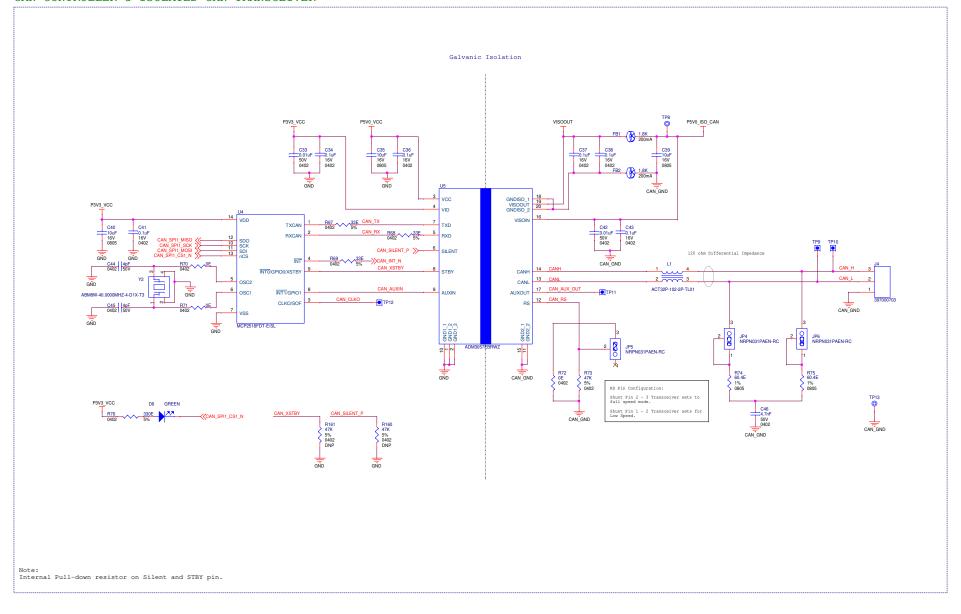
Chip Select Indication LEDs





CAN INTERFACE

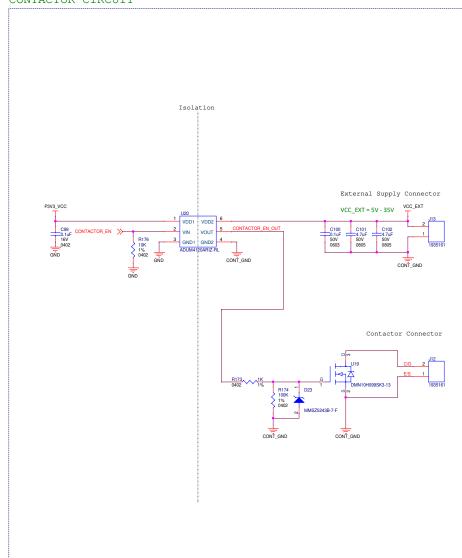
CAN CONTROLLER & ISOLATED CAN TRANSCEIVER



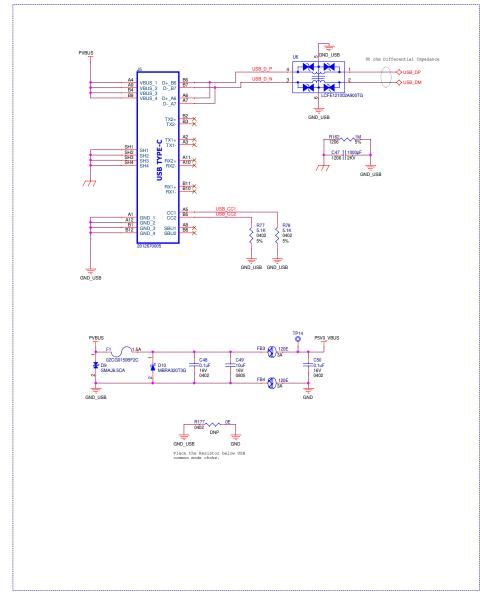


USB & CONTACTOR INTERFACE

CONTACTOR CIRCUIT



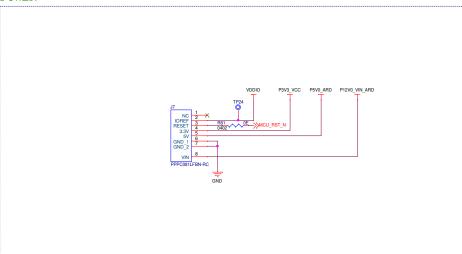
USB TYPE-C CONNECTOR



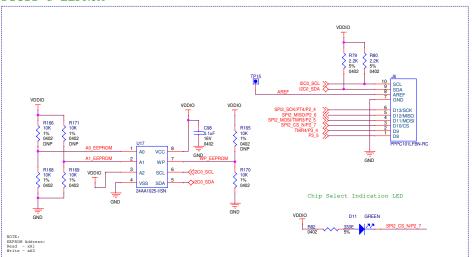


ARDUINO CONNECTOR

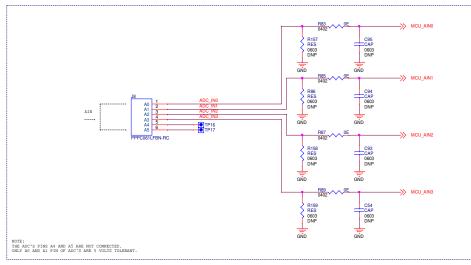




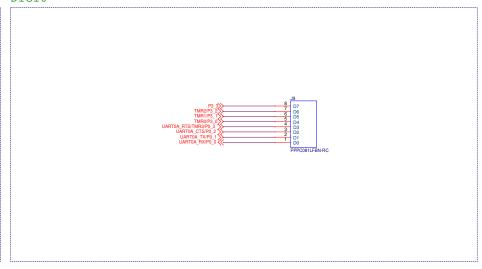
DIGI1 & EEPROM



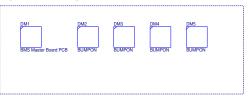
ANALOG CONNECTOR & INPUT PI FILTER



DIGI0

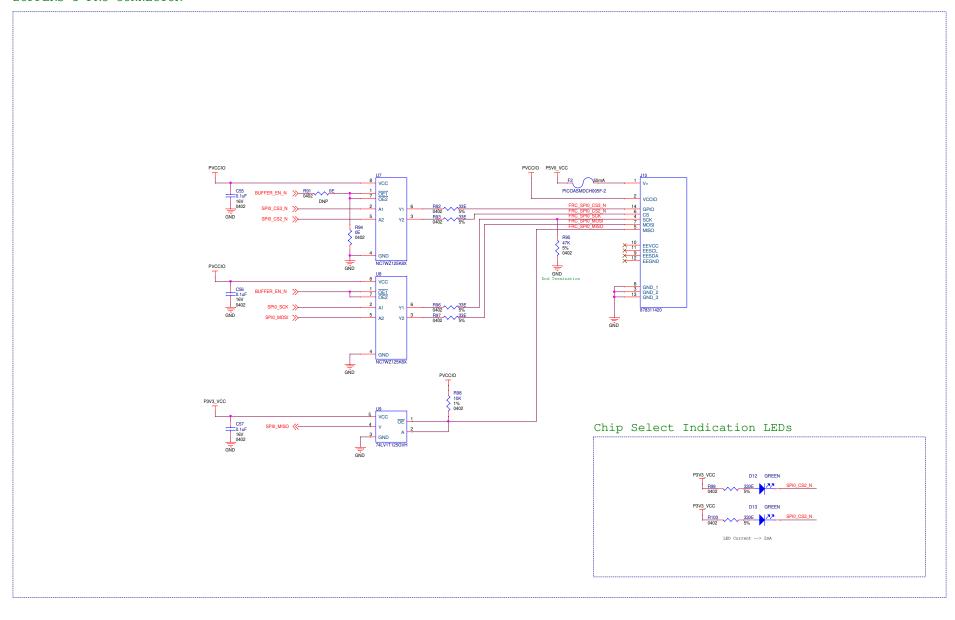


DUMMY PARTS

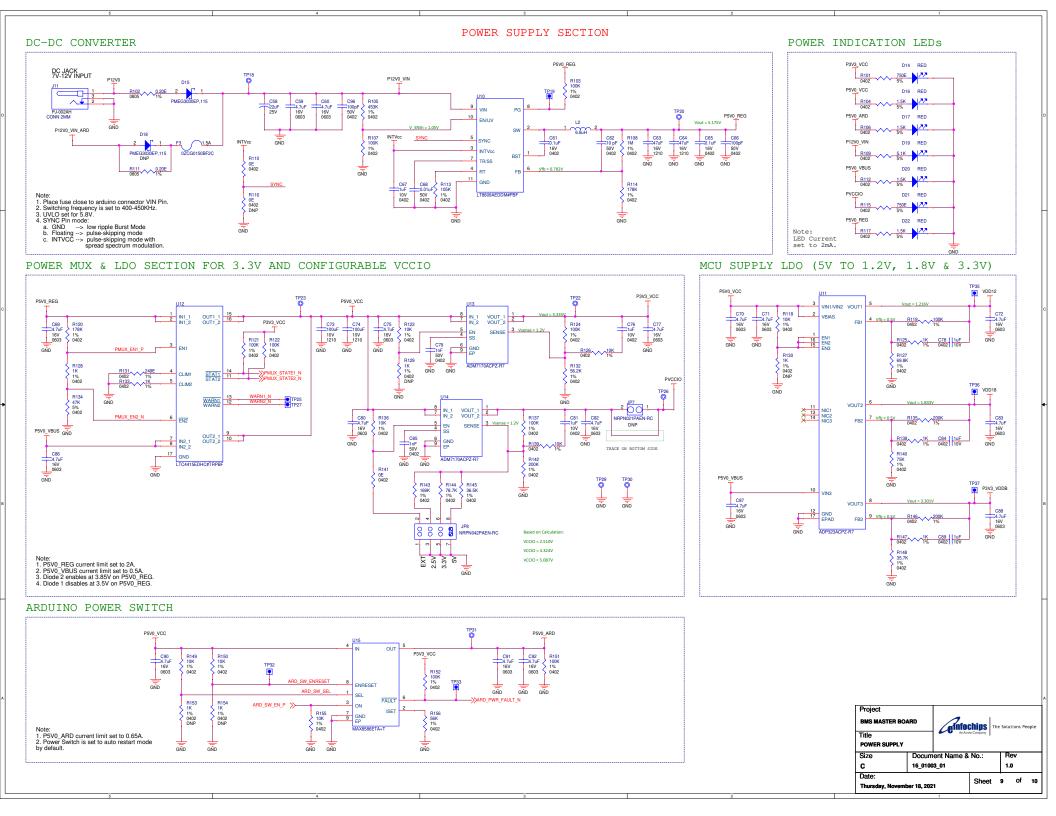




BUFFERS & FRC CONNECTOR







REVISION HISTORY

PCB REV	SCH REV	CHANGE DESCRIPTION	DATE	AUTHOR
	0.1	Create initial draft schematic.	20 SEP 2021	eInfochips
1.0	0.2	Internal review comments implemented.	06 OCT 2021	eInfochips
0.3	0.3	Replaced all 2.54mm Header with 2mm Header	07 OCT 2021	eInfochips
	0.4	1. Added 33 Ohm resistors on UART_TX, UART_RTS and removed from UART_RX and UART_CTS on Page 3, MCU section. 2. Corrected net name mismatch for SPI2_CS_N/P2_7 on Page 7, DIGI1 section	12 OCT 2021	eInfochips
0.5		Replaced R129, R130, R153 and R154 Enable pin 10K pull down provision to 1K in power supply section. Added 10K Enable pin pull down to ISOSPI LTC6820 IC. Changed the LTC4415 state pull-up to 3.3V. Removed Test Probe on VDD12, VDD18 and 3V3_VDDB and added Test Point. Added Test Probe on VDDIO. Added EEPROM on arduino I2C.	25 OCT 2021	eInfochips
	0.6	Added Contactor circuit. Swapped isoSPI tranformer channels as per the placement. Removed isolated DC-DC power supply and added 2-pin ternimal block for external power supply connections. Added zener diode across MOSFET Gate to source.	11 NOV 2021	eInfochips
	1.0	1. Changed R2 and R10 value to 2.2K. 2. Updated U10 part number. 3. R177 added between GND and GND_USB. 4. Baselined schematic as per customer approval.	18 NOV 2021	eInfochips

